

INVENTOR INFORMATION

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CORRESPONDENCE INFORMATION

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APPLICATION INFORMATION

Title Line One:: APPARATUS AND METHOD OF PLACING SOLDER B  
Title Line Two:: ALLS ONTO A SUBSTRATE  
Total Drawing Sheets:: 5  
Formal Drawings?:: Yes  
Application Type:: Utility  
Docket Number:: P/4076-10  
Secrecy Order in Parent Appl.?:: No

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